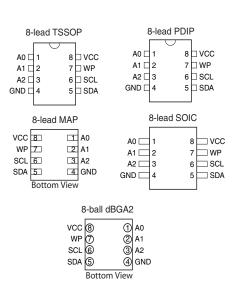
Features

- Write Protect Pin for Hardware Data Protection
 Utilizes Different Array Protection Compared to the AT24C02/04
- Low-voltage and Standard-voltage Operation
 - $-2.7 (V_{CC} = 2.7V \text{ to } 5.5V)$
 - 1.8 (V_{CC} = 1.8V to 5.5V)
- Internally Organized 256 x 8 (2K), 512 x 8 (4K)
- Two-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 100 kHz (1.8V) and 400 kHz (2.5V, 2.7V, 5V) Clock Rate
- 8-byte Page (2K), 16-byte Page (4K) Write Modes
- Partial Page Writes Allowed
- Self-timed Write Cycle (5 ms Max)
- High Reliability
 - Endurance: One Million Write Cycles
 - Data Retention: 100 Years
- Automotive Grade, Extended Temperature and Lead-Free/Halogen-Free Devices Available
- 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP, 8-lead TSSOP and 8-ball dBGA2 Packages
- Die Sales: Wafer Form, Waffle Pack, and Bumped Wafers.

Description

The AT24C02A/04A provides 2048/4096 bits of serial electrically erasable and programmable read-only memory (EEPROM) organized as 256/512 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where lowpower and low-voltage operation are essential. The AT24C02A/04A is available in space-saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP and 8-lead TSSOP packages and is accessed via a two-wire serial interface. In addition, the entire family is available in 2.7V (2.7V to 5.5V) and 1.8V (1.8V to 5.5V) versions.

Pin Name	Function
A0-A2	Address Inputs
SDA	Serial Data
SCL	Serial Clock Input
WP	Write Protect
NC	No-connect





Two-wire Serial EEPROM

2K (256 x 8)

4K (512 x 8)

AT24C02A AT24C04A

Rev. 0976Q-SEEPR-8/05



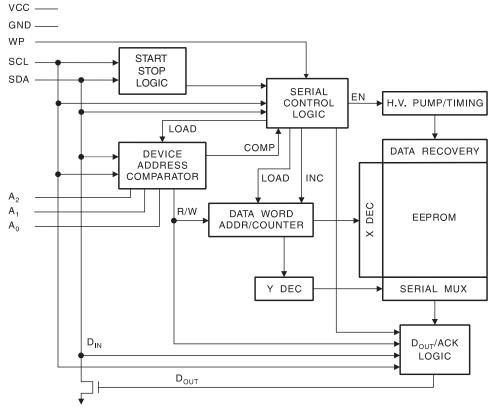


Absolute Maximum Ratings*

Operating Temperature40°C to +85°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground1.0V to +7.0V
Maximum Operating Voltage 6.25V
DC Output Current

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





Pin DescriptionSERIAL CLOCK (SCL):

SERIAL CLOCK (SCL): The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.

SERIAL DATA (SDA): The SDA pin is bidirectional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open collector devices.

DEVICE/PAGE ADDRESSES (A2, A1, A0): The A2, A1 and A0 pins are device address inputs that must be hardwired for the AT24C02A. As many as eight 2K devices may be addressed on a single bus system. (Device addressing is discussed in detail under *Device Addressing*, page 8).

² AT24C02A/04A

The AT24C04A uses the A2 and A1 inputs for hardwire addressing, and a total of four 4K devices may be addressed on a single bus system. The A0 pin is a no-connect.

WRITE PROTECT (WP): The AT24C02A/04A have a WP pin that provides hardware data protection. The WP pin allows normal read/write operations when connected to ground (GND). When the WP pin is connected to V_{CC} , the write protection feature is enabled and operates as shown.

Table 2. Write Protect

	Part of the Array Protected		
WP Pin Status	24C02A 24C04A		
At V _{CC}	Upper Half (1K) Array Upper Half (2K) Array		
At GND	Normal Read/Write Operations		

Memory Organization AT24C02A, 2K SERIAL EEPROM: The 2K is internally organized with 32 pages of 8 bytes each. Random word addressing requires an 8-bit data word address.

AT24C04A, 4K SERIAL EEPROM: The 4K is internally organized with 32 pages of 16 bytes each. Random word addressing requires a 9-bit data word address.

Table 3. Pin Capacitance⁽¹⁾

Applicable over recommended operating range from $T_{AI} = 25^{\circ}C$, f = 1.0 MHz, $V_{CC} = +1.8V$

Symbol	Test Condition	Max	Units	Conditions
C _{I/O}	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
C _{IN}	Input Capacitance (A ₀ , A ₁ , A ₂ , SCL)	6	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.





Table 4. DC Characteristics

Applicable over recommended o	· · · · · · · · · · · · · · · · · · ·	4000 1. 0500 1/		
Upplicable aver recommended of	$\mathbf{p}_{\mathbf{r}}$			1000000000000000000000000000000000000
	$\mathbf{D} \in [\mathbf{A} \cup [\mathbf{D} \cup [\mathbf{A} \cup [\mathbf{D} \cup \mathbf{D} \cup D$	+0 0 10 $+03$ 0. V cc $=$ T	1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0	

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
V _{CC1}	Supply Voltage		1.8		5.5	V
V _{CC2}	Supply Voltage		2.5		5.5	V
V _{CC3}	Supply Voltage		2.7		5.5	V
V _{CC4}	Supply Voltage		4.5		5.5	V
I _{cc}	Supply Current V _{CC} = 5.0V	READ at 100 kHz		0.4	1.0	mA
I _{CC}	Supply Current V _{CC} = 5.0V	WRITE at 100 kHz		2.0	3.0	mA
I _{SB1}	Standby Current V _{CC} = 1.8V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		0.6	3.0	μA
I _{SB2}	Standby Current V _{CC} = 2.5V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		1.4	4.0	μA
I _{SB3}	Standby Current V _{CC} = 2.7V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		1.6	4.0	μA
I _{SB4}	Standby Current V _{CC} = 5.0V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		8.0	18.0	μA
ILI	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } V_{SS}$		0.10	3.0	μA
I _{LO}	Output Leakage Current	$V_{OUT} = V_{CC} \text{ or } V_{SS}$		0.05	3.0	μA
V _{IL}	Input Low Level (1)		-0.6		V _{CC} x 0.3	V
V _{IH}	Input High Level (1)		V _{CC} x 0.7		V _{CC} + 0.5	V
V _{OL2}	Output Low Level V _{CC} = 3.0V	I _{OL} = 2.1 mA			0.4	V
V _{OL1}	Output Low Level V _{CC} = 1.8V	I _{OL} = 0.15 mA			0.2	V

Note: 1. V_{IL} min and V_{IH} max are reference only and are not tested.

Table 5. AC Characteristics

Applicable over recommended operating range from $T_{AI} = -40^{\circ}C$ to $+85^{\circ}C$, $V_{CC} = +1.8V$ to +5.5V, CL = 1 TTL Gate and 100 pF (unless otherwise noted)

	Parameter	1.8-volt		2.5, 2.7, 5.0-volt		
Symbol		Min	Max	Min	Max	Units
f _{SCL}	Clock Frequency, SCL		100		400	kHz
t _{LOW}	Clock Pulse Width Low	4.7		1.2		μs
t _{HIGH}	Clock Pulse Width High	4.0		0.6		μs
t _I	Noise Suppression Time ⁽²⁾		100		50	ns
t _{AA}	Clock Low to Data Out Valid	0.1	4.5	0.1	0.9	μs
t _{BUF}	Time the bus must be free before a new transmission can start ⁽¹⁾	4.7		1.2		μs
t _{HD.STA}	Start Hold Time	4.0		0.6		μs
t _{SU.STA}	Start Set-up Time	4.7		0.6		μs
t _{HD.DAT}	Data In Hold Time	0		0		μs
t _{SU.DAT}	Data In Set-up Time	200		100		ns
t _R	Inputs Rise Time ⁽¹⁾		1.0		0.3	μs
t _F	Inputs Fall Time ⁽¹⁾		300		300	ns
t _{SU.STO}	Stop Set-up Time	4.7		0.6		μs
t _{DH}	Data Out Hold Time	100		50		ns
t _{WR}	Write Cycle Time		5		5	ms
Endurance ⁽¹⁾	5.0V, 25°C, Page Mode	1M		1M		Write Cycles

Note: 1. This parameter is characterized and is not 100% tested.

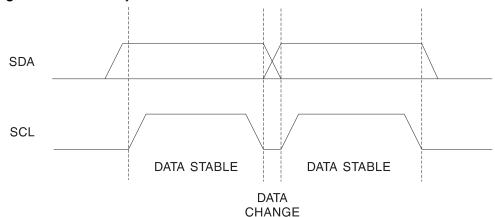


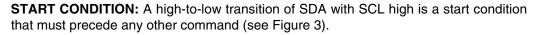


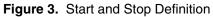
Device Operation

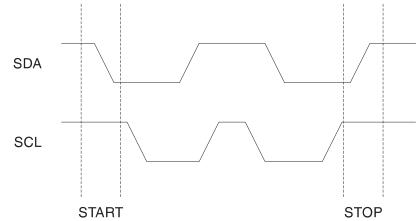
CLOCK and DATA TRANSITIONS: The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see Figure 2). Data changes during SCL high periods will indicate a start or stop condition as defined below.











STOP CONDITION: A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode (see Figure 3).

ACKNOWLEDGE: All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a "0" to acknowledge that it has received each word. This happens during the ninth clock cycle.

STANDBY MODE: The AT24C02A/04A/08A/16A features a low-power standby mode that is enabled: (a) upon power-up and (b) after the receipt of the Stop bit and the completion of any internal operations.

MEMORY RESET: After an interruption in protocol, power loss or system reset, any two-wire part can be reset by following these steps:

- 1. Clock up to 9 cycles
- 2. Look for SDA high in each cycle while SCL is high
- 3. Create a start condition as SDA is high.

6 **AT24C02A/04A**

Figure 4. Bus Timing

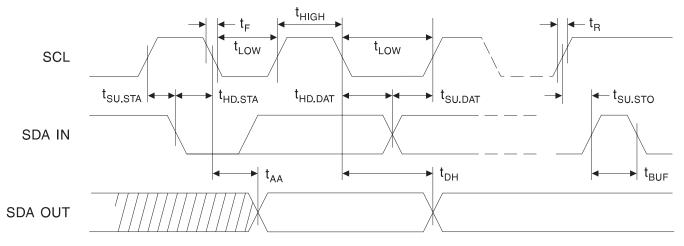
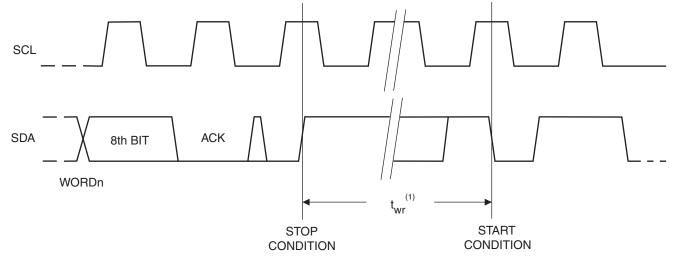
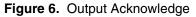
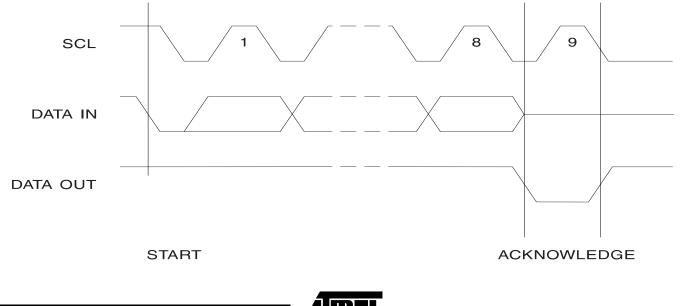


Figure 5. Write Cycle Timing



Notes: 1. The write cycle time t_{WR} is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.



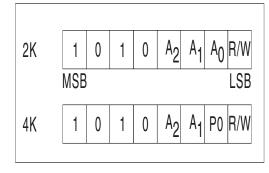




Device Addressing

The 2K and 4K EEPROM devices require an 8-bit device address word following a start condition to enable the chip for a read or write operation, as shown in Figure 7.





The device address word consists of a mandatory "1", "0" sequence for the first four most significant bits as shown. This is common to all the EEPROM devices.

The next three bits are the A2, A1 and A0 device address bits for the 2K EEPROM. These three bits must compare to their corresponding hardwired input pins.

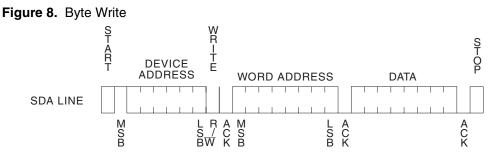
The 4K EEPROM only uses the A2 and A1 device address bits with the third bit being a memory page address bit. The two device address bits must compare to their corresponding hardwired input pins. The A0 pin is no-connect.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high, and a write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a "0". If a compare is not made, the chip will return to a standby state.

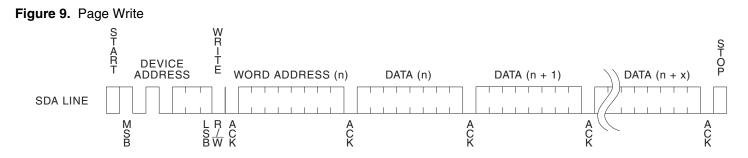
Write Operations

BYTE WRITE: A write operation requires an 8-bit data word address following the device address word and acknowledgement. Upon receipt of this address, the EEPROM will again respond with a "0" and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a "0" and the addressing device, such as a microcontroller, must terminate the write sequence with a stop condition. At this time, the EEPROM enters an internally-timed write cycle, t_{WR} , to the nonvolatile memory. All inputs are disabled during this write cycle, and the EEPROM will not respond until the write is complete, see Figure 8 on page 8.



PAGE WRITE: The 2K EEPROM is capable of an 8-byte page write, and the 4K device is capable of 16-byte page writes.

A page write is initiated the same as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to seven (2K) or fifteen (4K) more data words. The EEPROM will respond with a "0" after each data word received. The microcontroller must terminate the page write sequence with a stop condition, see Figure 9.



The data word address lower three (2K) or four (4K) bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than eight (2K) or sixteen (4K) data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.

ACKNOWLEDGE POLLING: Once the internally-timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a "0" allowing the read or write sequence to continue.





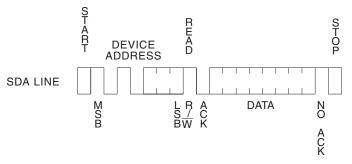
Read Operations

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to "1". There are three read operations: current address read, random address read and sequential read.

CURRENT ADDRESS READ: The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

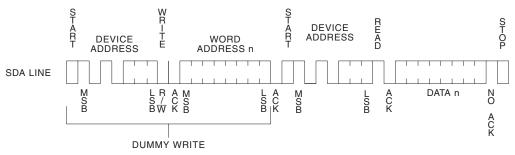
Once the device address with the read/write select bit set to "1" is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input "0" but does generate a following stop condition, see Figure 10.





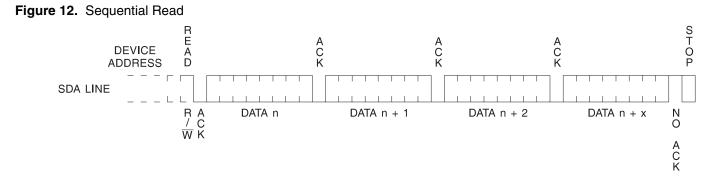
RANDOM READ: A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a "0" but does generate a following stop condition, see Figure 11.





SEQUENTIAL READ: Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledge. As long as the EEPROM receives an acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequen-

tial read will continue. The sequential read operation is terminated when the microcontroller does not respond with a "0" but does generate a following stop condition, see Figure 12.







AT24C02A Ordering Information⁽¹⁾

Ordering Code	Package	Operation Range
AT24C02A-10PI-2.7	8P3	Industrial Temperature
AT24C02AN-10SI-2.7	8S1	Industrial Temperature
AT24C02A-10TI-2.7	8A2	(–40°C to 85°C)
AT24C02A-10PI-1.8	8P3	
AT24C02AN-10SI-1.8	8S1	Industrial Temperature
AT24C02A-10TI-1.8	8A2	(−40°C to 85°C)
AT24C02A-10PU-2.7 ⁽²⁾	8P3	
AT24C02A-10PU-1.8 ⁽²⁾	8P3	
AT24C02AN-10SU-2.7 ⁽²⁾	8S1	
AT24C02AN-10SU-1.8 ⁽²⁾	8S1	Lead-free/Halogen-free/
AT24C02A-10TU-2.7 ⁽²⁾	8A2	Industrial Temperature
AT24C02A-10TU-1.8 ⁽²⁾	8A2	(–40°C to 85°C)
AT24C02AY1-10YU-1.8 ⁽²⁾	8Y1	
AT24C02AU3-10UU-1.8 ⁽²⁾	8U3-1	
AT24C02A-W2.7-11 ⁽³⁾	Die Sale	Industrial Temperature
AT24C02A-W1.8-11 ⁽³⁾	Die Sale	(−40°C to 85°C)

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

2. "U" designates Green Package + RoHS compliant

3. Available in waffle pack and wafer form; order as SL719 for wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

	Package Type			
8P3	8-pin, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
8U3-1	8-ball, die Ball Grid Array Package (dBGA2)			
	Options			
-2.7	Low Voltage (2.7V to 5.5V)			
-1.8	Low Voltage (1.8V to 5.5V)			

AT24C04A Ordering Information⁽¹⁾

Ordering Code	Package	Operation Range
AT24C04A-10PI-2.7	8P3	
AT24C04AN-10SI-2.7	8S1	Industrial Temperature
AT24C04A-10TI-2.7	8A2	(−40°C to 85°C)
AT24C04A-10PI-1.8	8P3	
AT24C04AN-10SI-1.8	8S1	Industrial Temperature
AT24C04A-10TI-1.8	8A2	(–40°C to 85°C)
AT24C04A-10PU-2.7 ⁽²⁾	8P3	
AT24C04A-10PU-1.8 ⁽²⁾	8P3	
AT24C04AN-10SU-2.7 ⁽²⁾	8S1	
AT24C04AN-10SU-1.8 ⁽²⁾	8S1	Lead-free/Halogen-free/
AT24C04A-10TU-2.7 ⁽²⁾	8A2	Industrial Temperature (-40°C to 85°C)
AT24C04A-10TU-1.8 ⁽²⁾	8A2	(-40 C 10 85 C)
AT24C04AY1-10YU-1.8 ⁽²⁾	8Y1	
AT24C04AU3-10UU-1.8 ⁽²⁾	8U3-1	
AT24C04A-W2.7-11 ⁽³⁾	Die Sale	Industrial Temperature
AT24C04A-W1.8-11 ⁽³⁾	Die Sale	(−40°C to 85°C)

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table. 2. "U" designates Green Package + RoHS compliant

3. Available in waffle pack and wafer form; order as SL719 for wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

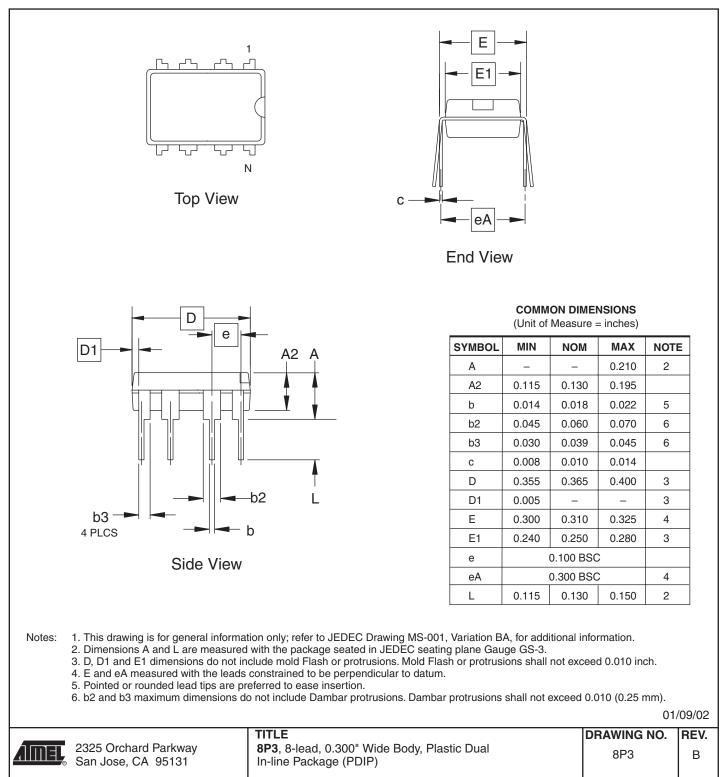
	Package Type			
8P3	8P3 8-pin, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)			
8Y1	8Y1 8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
8U3-1	3-1 8-ball, die Ball Grid Array Package (dBGA2)			
	Options			
-2.7	-2.7 Low Voltage (2.7V to 5.5V)			
-1.8	Low Voltage (1.8V to 5.5V)			



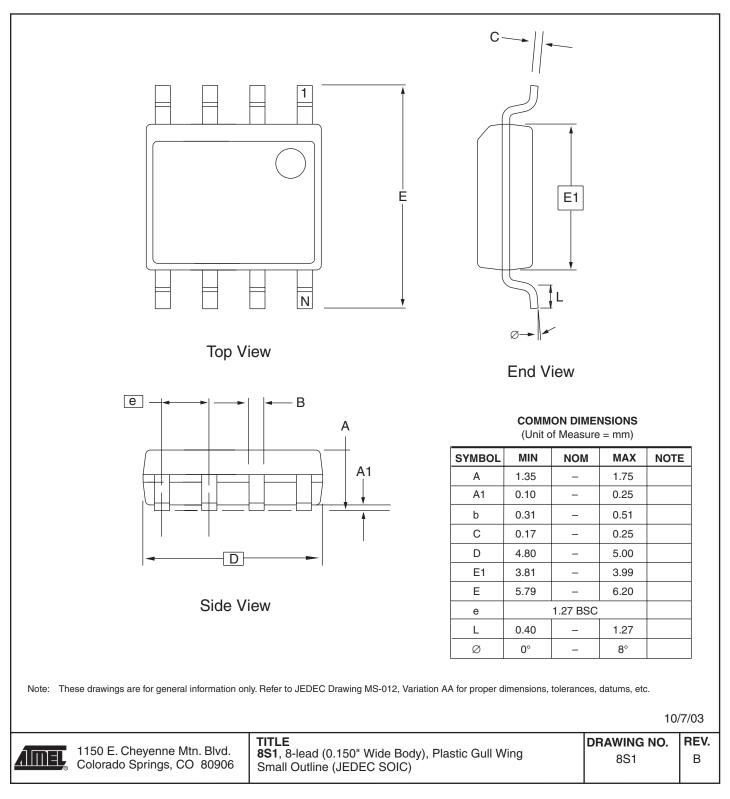


Packaging Information

8P3 – PDIP



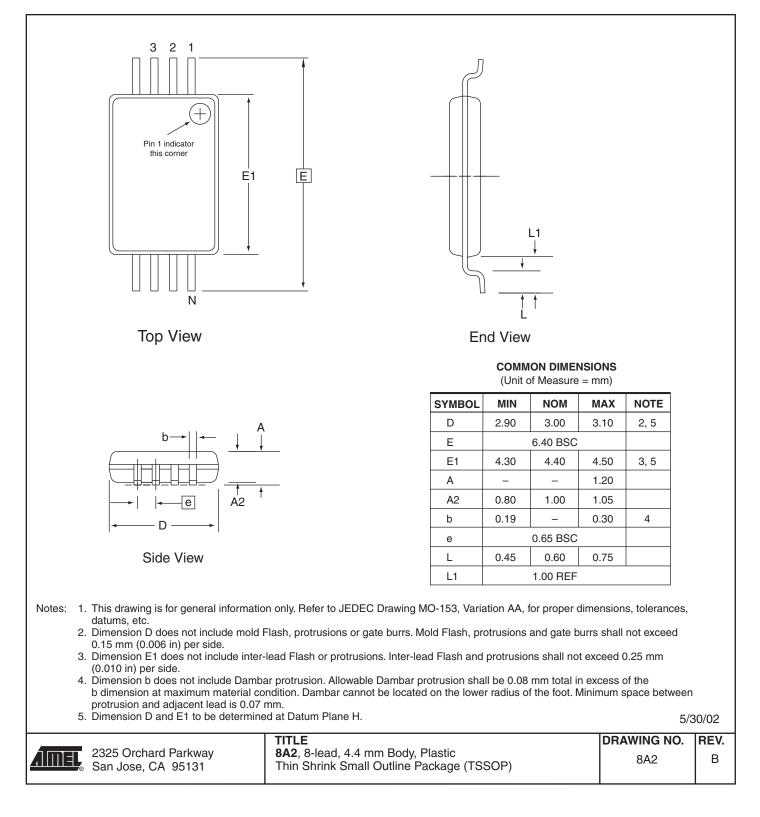
8S1 – JEDEC SOIC



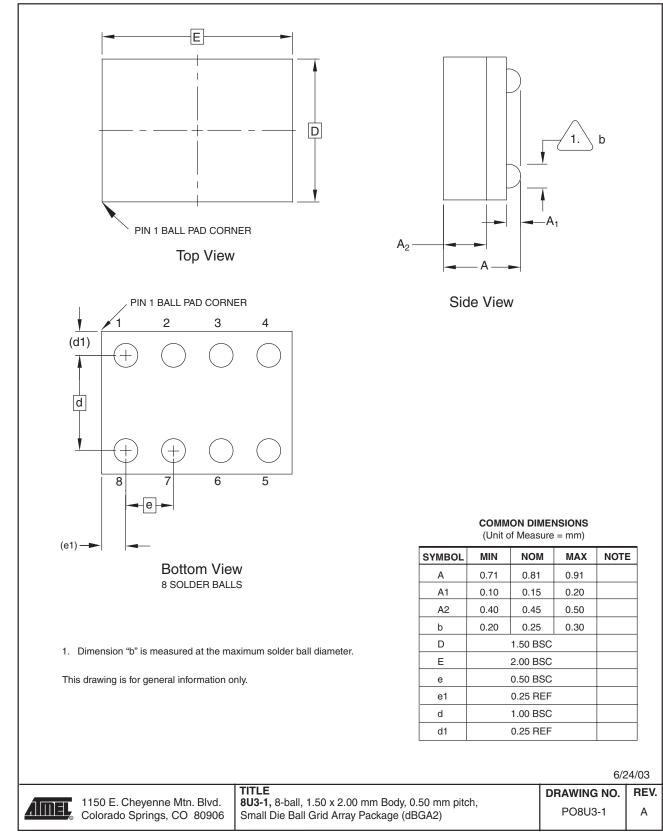




8A2 – TSSOP



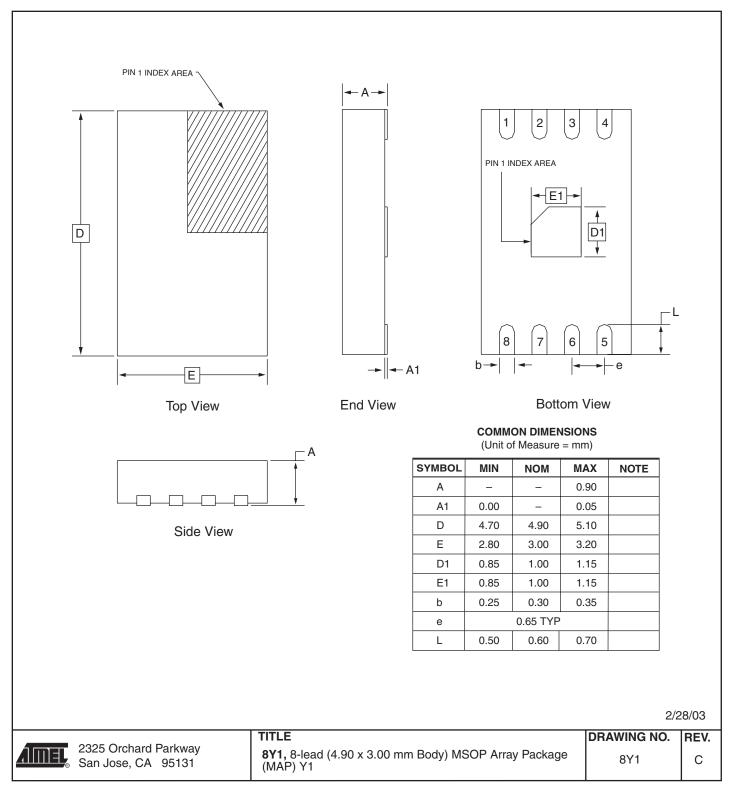
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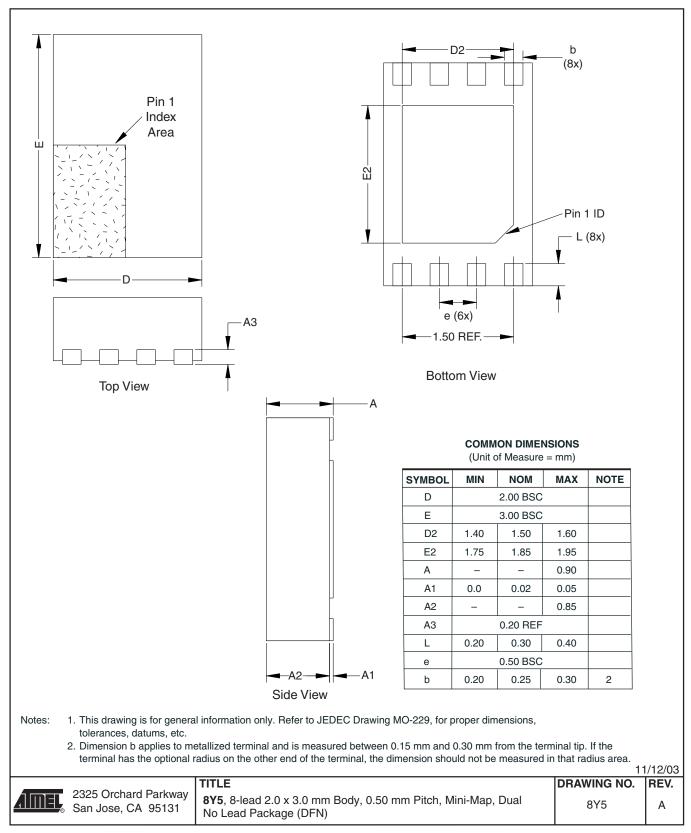




8Y1 – MAP











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Theresienstrasse 2 Postfach 3535 74025 Heilbronn, Germany Tel: (49) 71-31-67-0 Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

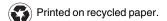
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